

The product using material and processing must conform to the "WL-PZ-001"HSF technical standard control requirements

RoHS

34.80±0.50

3.50

4.20

29.40±0.35

Circuit1

9.60

1.300

12.8

4.200

SQ1.14

29.40

4.20

ø1.8

4.200

(空8、16PIN)

NOTE:

1.MATERIAL SPECIFICATION:

1-1.HOUSING: PA66

1-2.CONTACTS: BRASS

2.PLATING SPECIFICATION:

2-1.CONTACTS:

TIN/GOLD FLASH PLATED OVER ALL.

3.MECHANICAL PERFORMANCE:

3-1.INSERTION FORCE: 1.6kgf MAX

3-2.REMOVAL FORCE: 0.4kgf MIN

3-3.DURABILITY: 30 CYCLES.

4.ELECTRICAL PERFORMANCE:

4-1.CURRENT RATING: 9A AC/DC

RATED VOLTAGE : 600V AC/DC

4-2.CONTACT RESISTANCE: 10 mΩ MAX

4-3.INSULATION RESISTANCE: 1000MΩ Min

4-4.DIELECTRIC WITHSTANDING : 1500V

5.ENVIRONMENTAL PERFORMANCE:

5-1.OPERATING TEMPERATURE: -40°C~+105°C.

6.PACKAGE SPEC: PE BAG

7.P/N:

C42018 F 0-2 XX 1 X X X

SERIES NO:

MALE FEMALE:

F-FEMALE

ANGLE:

0-180°

9-90°

ROW NO:

2-DOUBLE ROW

PIN Q'PY:

16

TERMIPOINT:

1-DIP

WATER CODE

0-UL94V-0

2-UL94V-2

COLOR:

A-BLACK

K-WHITE

S-NATURE

PLATING:

A-ALL AU G/F

C-BRIGHE TIN

D-MATTE Tin

REV.	REVISION RECORD	DATE		GENERAL TOLERANCES		SCALE: 1:1	NAME	DATE	PART.NO:	DWG.NO:		
AO	NEW RELEASE	21.11.17		LINEAR	ANGLES	APPROVED						Wang_jr
			UNIT:mm	0.0±0.35	X'REF±6°	DESIGNER	Han_Gao	21.11.17	TITLE:	Pitch 4.2mm 双排 180° DIP Wafer 实心针	REV: A0	SHEET: 1/2
				0.00±0.25	X'±3°	DRAWN	Zijun_Huang	21.11.17				
			SIZE: A4	0.000±0.10	X'X' ±2°							

1

2

3

4

5

6

7

8